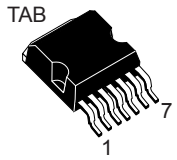
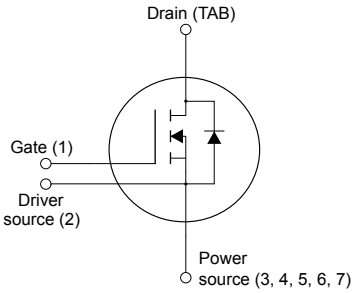
SCTH100N65G2-7AG

Datasheet

Automotive-grade silicon carbide Power MOSFET, 650 V, 95 A, 20 mΩ (typ., T_J = 25 °C) in an H²PAK-7 package



H²PAK-7



Features

Order code	V_{DS}	$R_{DS(on)}$ typ.	I_D
SCTH100N65G2-7AG	650 V	20 mΩ	95 A

- AEC-Q101 qualified
- Very fast and robust intrinsic body diode
- Low capacitance

Applications

- Traction inverters
- DC-DC converters
- OBC

Description

This silicon carbide Power MOSFET device has been developed using ST's advanced and innovative 2nd generation SiC MOSFET technology. The device features remarkably low on-resistance per unit area and very good switching performance.

Product status link
SCTH100N65G2-7AG

Product summary	
Order code	SCTH100N65G2-7AG
Marking	100N65AG
Package	H²PAK-7
Packing	Tape and reel

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	-10 to 22	V
	Gate-source voltage (recommended operational values)	-5 to 18	
V_{DS}	Drain-source voltage	650	V
I_D	Drain current (continuous) at T_C = 25 °C	95	A
	Drain current (continuous) at T_C = 100 °C	65	
I_D(1)	Drain current (pulsed)	260	A
P_{TOT}	Total power dissipation at T_C = 25 °C	360	W
T_{stg}	Storage temperature range	-55 to 175	°C
T_J	Operating junction temperature range		°C

1. *Pulse width is limited by safe operating area.*

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj\text{-}case}$	Thermal resistance junction-case	0.42	°C/W
$R_{thj\text{-}amb}$	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	650			V
I_{DSS}	Zero gate voltage drain current	V_{GS} = 0 V, V_{DS} = 650 V		1	10	µA
		V_{GS} = 0 V, V_{DS} = 650 V, T_J = 175 °C		25		
I_{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = 22 V, T_J = 175 °C		20		nA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS}, I_D = 5 mA	1.9	3.1	5	V
$R_{DS(on)}$	Static drain-source on-resistance	V_{GS} = 18 V, I_D = 50 A		20	26	mΩ
		V_{GS} = 18 V, I_D = 50 A, T_J = 175 °C		32		

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	V_{DS} = 520 V, f = 1 MHz, V_{GS} = 0 V	-	3315	-	pF
C_{oss}	Output capacitance		-	267	-	pF
C_{rss}	Reverse transfer capacitance		-	46	-	pF
Q_g	Total gate charge	V_{DS} = 520 V, V_{GS} = -5 to 18 V, I_D= 50 A	-	162	-	nC
Q_{gs}	Gate-source charge		-	45	-	nC
Q_{gd}	Gate-drain charge		-	49	-	nC
R_g	Gate input resistance	f=1 MHz, I_D = 0 A	-	1	-	Ω

Table 5. Switching energy

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
E_{on}	Turn-on switching energy	V_{DD} = 520 V, I_D = 50 A	-	486	-	µJ
E_{off}	Turn-off switching energy	R_G= 10 Ω, V_{GS} = -5 to 18 V	-	506	-	µJ

Table 6. Reverse SiC diode characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{SD}	Diode forward voltage	I_F = 30 A, V_{GS} = 0 V	-	3.5	-	V
t_{rr}	Reverse recovery time	I_{SD} = 50 A, di/dt = 2140 A/µs V_{DD} = 520 V, R_G= 10 Ω, V_{GS}= -5 V	-	26		ns
Q_{rr}	Reverse recovery charge		-	370	-	nC
I_{RRM}	Reverse recovery current		-	24	-	A

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

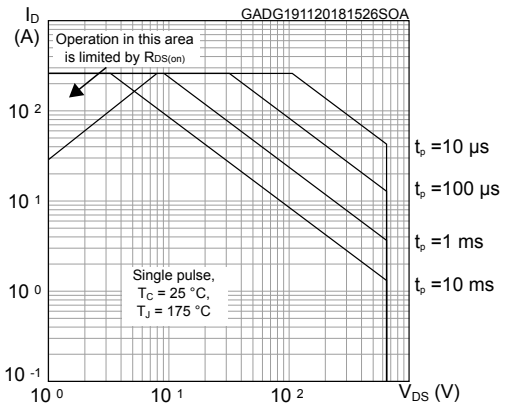


Figure 2. Thermal impedance

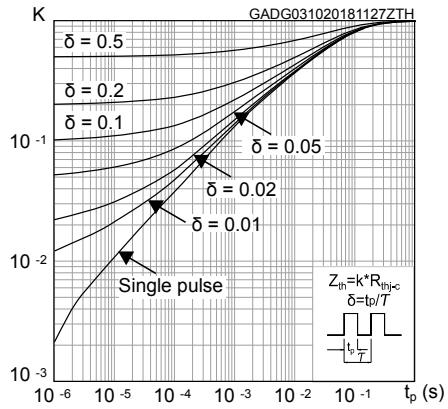


Figure 3. Output characteristics (T_J = 25 °C)

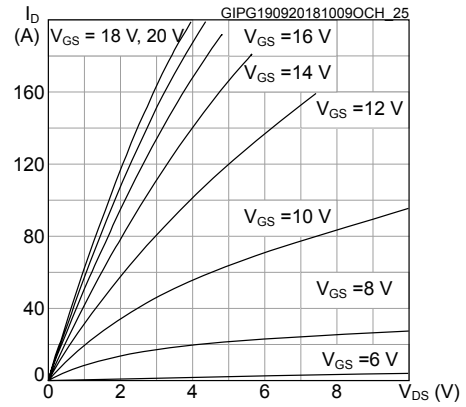


Figure 4. Output characteristics (T_J = 175 °C)

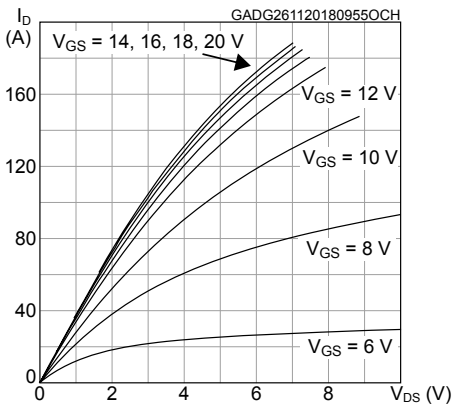


Figure 5. Transfer characteristics

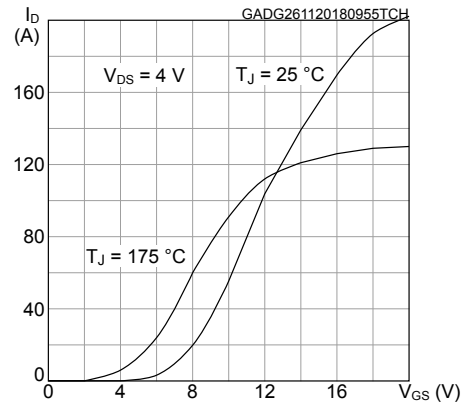


Figure 6. Power dissipation

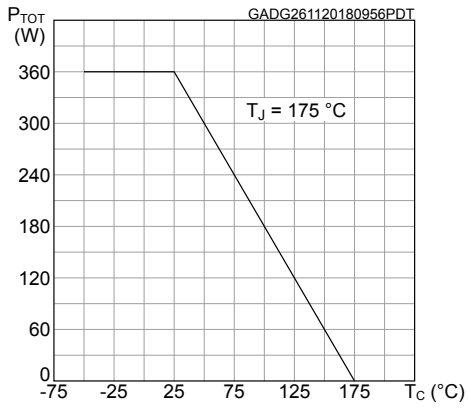


Figure 7. Gate charge vs gate-source voltage

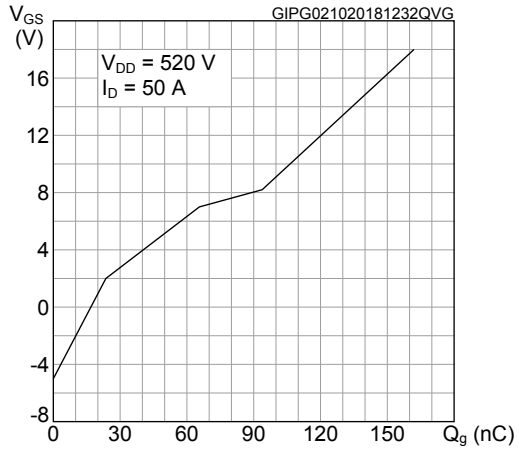


Figure 8. Capacitance variations

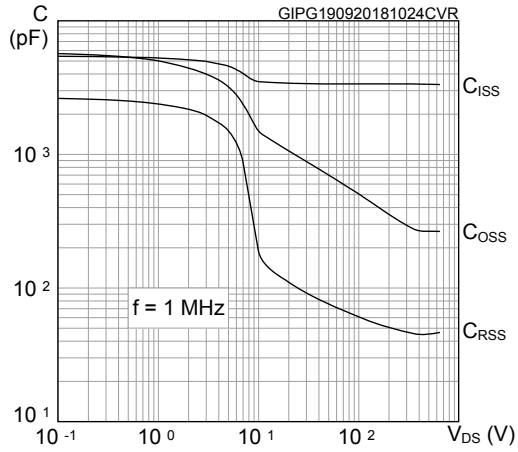


Figure 9. Switching energy vs drain current

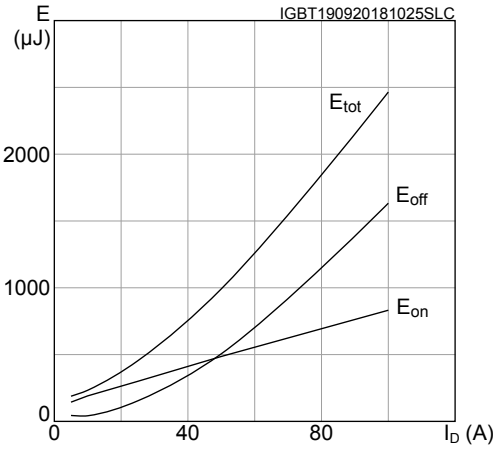


Figure 10. Normalized $V_{(BR)DSS}$ vs temperature

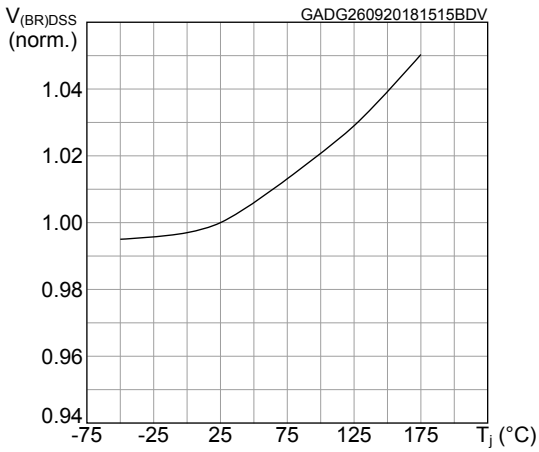


Figure 11. Normalized gate threshold voltage

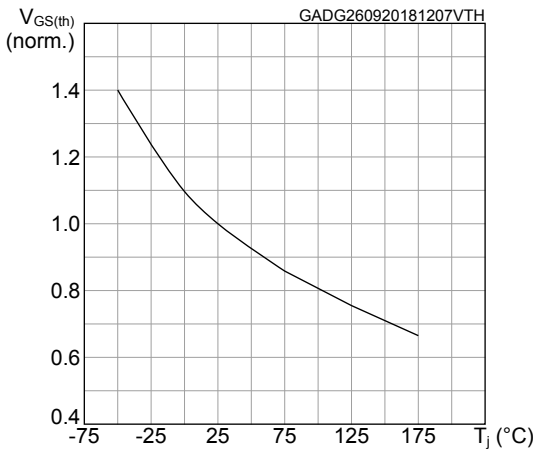


Figure 12. Switching energy vs junction temperature

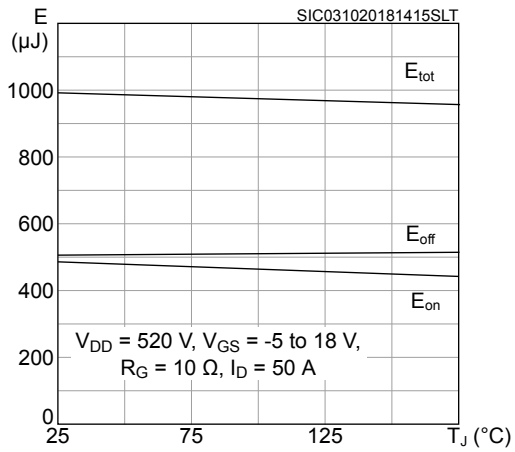


Figure 13. Switching energy vs gate resistance

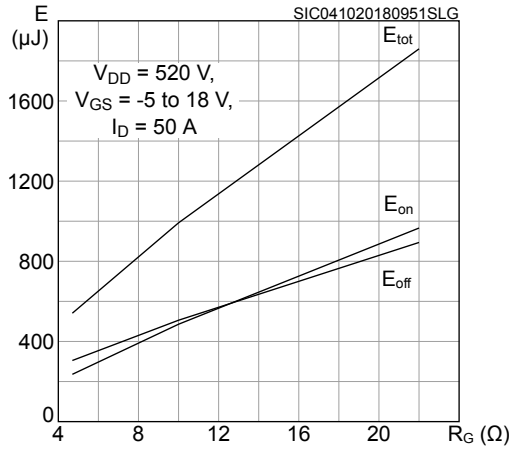


Figure 14. Normalized on-resistance vs temperature

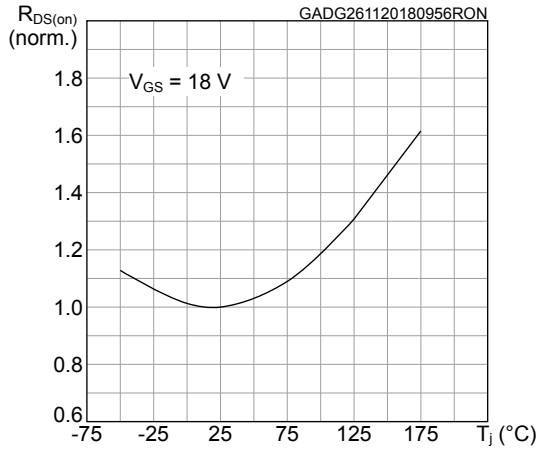


Figure 15. Body diode characteristics (T_J = 25 °C)

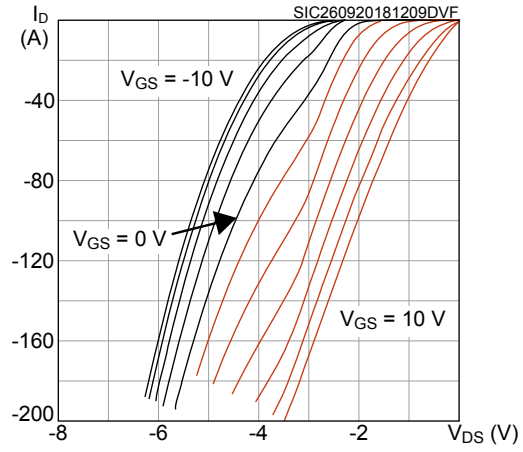
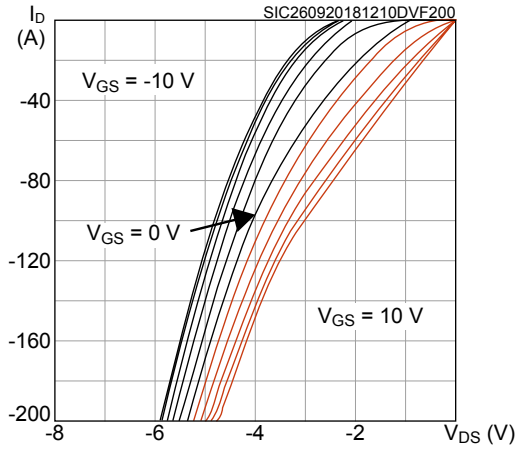


Figure 16. Body diode characteristics (T_J = 175 °C)



3 Test circuits

Figure 17. Test circuit for resistive load switching times

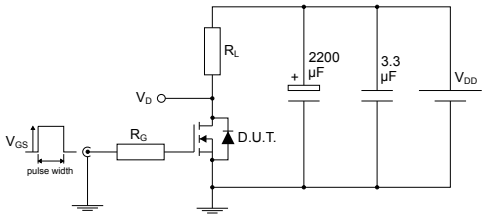


Figure 18. Test circuit for gate charge behavior

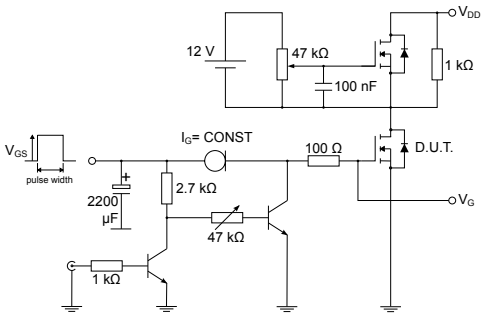


Figure 19. Test circuit for inductive load switching and diode recovery times

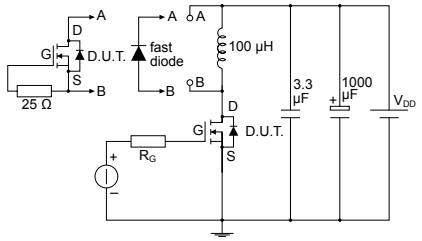


Figure 20. Unclamped inductive load test circuit

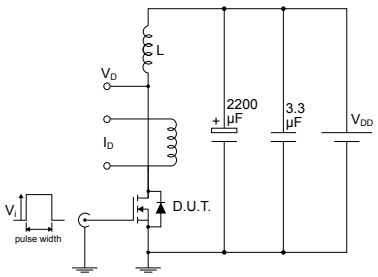


Figure 21. Unclamped inductive waveform

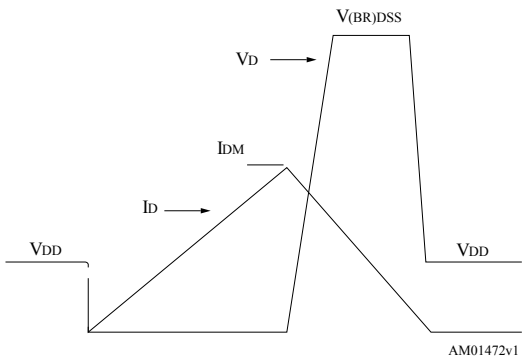
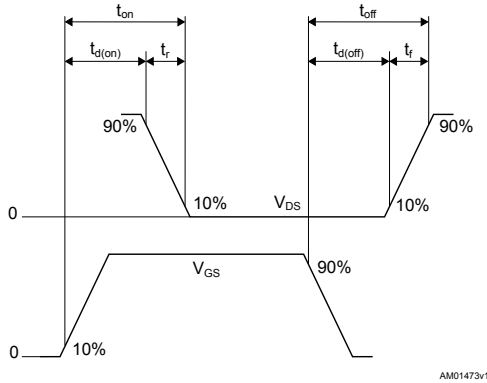


Figure 22. Switching time waveform

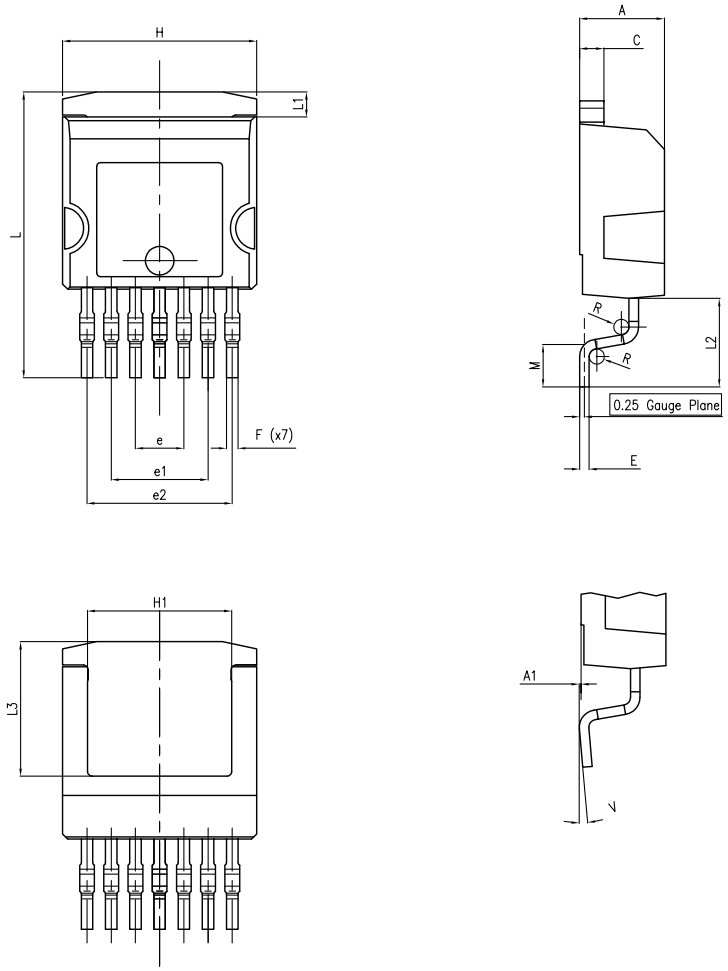


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 H²PAK-7 package information

Figure 23. H²PAK-7 package outline

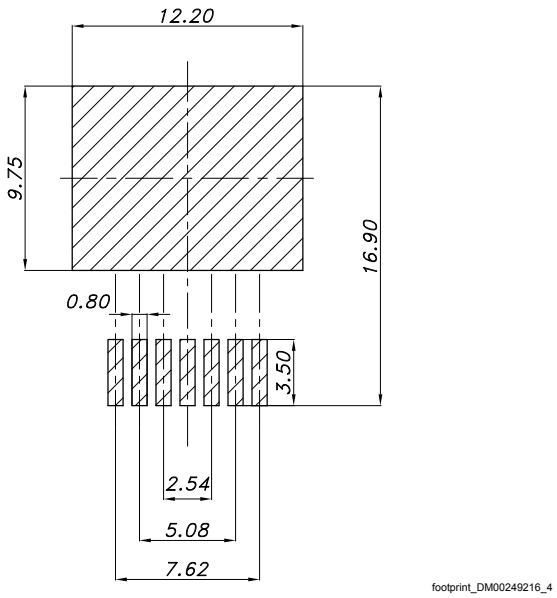


DM00249216_4

Table 7. **H²PAK-7 package mechanical data**

Dim.	mm	
	Min.	Max.
A	4.30	4.80
A1	0.03	0.20
C	1.17	1.37
e	2.34	2.74
e1	4.88	5.28
e2	7.42	7.82
E	0.45	0.60
F	0.50	0.70
H	10.00	10.40
H1	7.40	7.60
L	14.75	15.25
L1	1.27	1.40
L2	4.35	4.95
L3	6.85	7.25
M	1.90	2.50
R	0.20	0.60
V	0°	8°

Figure 24. **H²PAK-7 recommended footprint**



Note: Dimensions are in mm.

4.2 Packing information

Figure 25. **Tape outline**

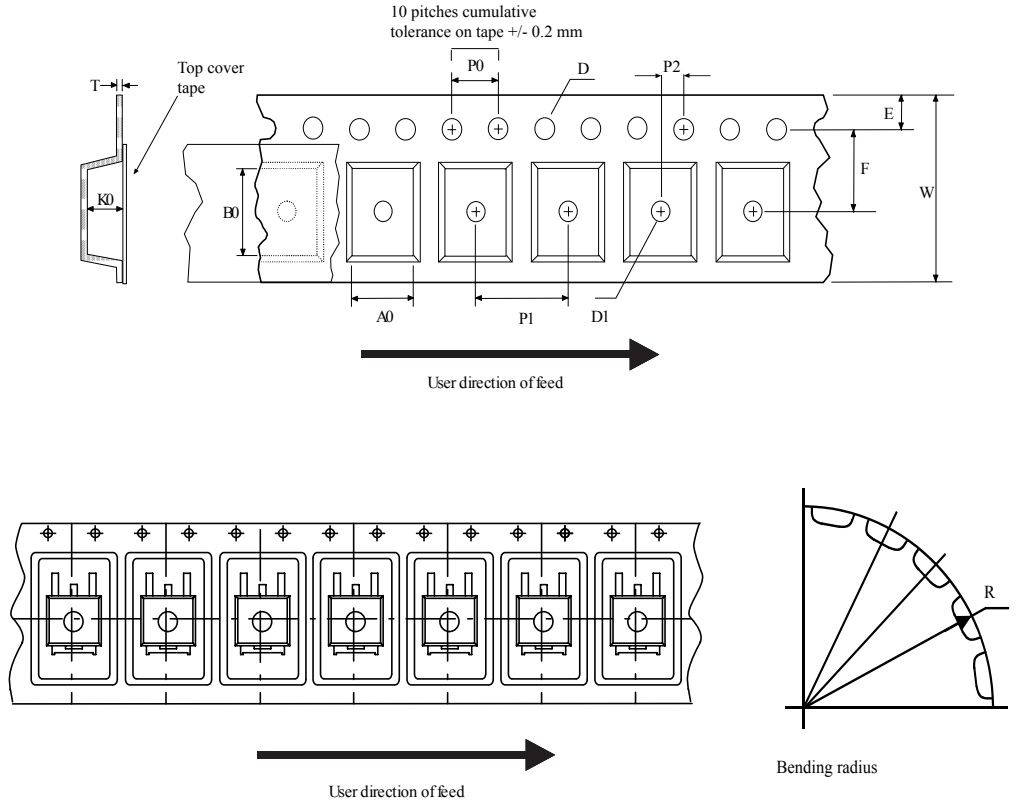


Figure 26. **Reel outline**

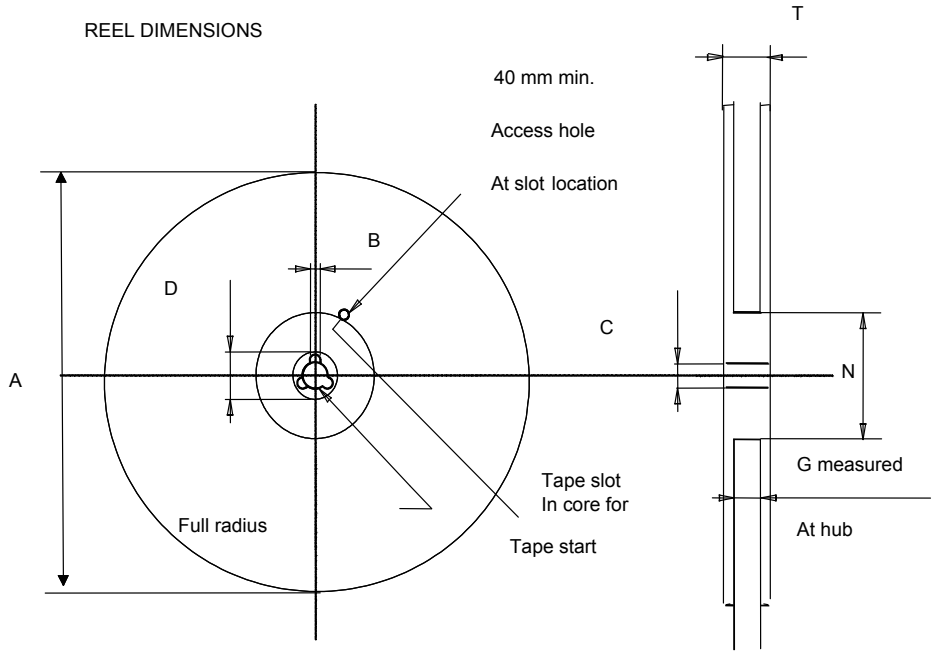


Table 8. **Tape and reel mechanical data**

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base quantity		1000
P2	1.9	2.1	Bulk quantity		1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

Revision history

Table 9. **Document revision history**

Date	Version	Changes
27-Nov-2018	1	First release.

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